Microsemi
POWER PRODUCTS GROUP

ARF1500

RF POWER MOSFET
N-CHANNEL ENHANCEMENT MODE

S   D   S

ARF1500
BeO   1525-xx

S   G   S

125V   750W   40MHz

The ARF1500 is an RF power transistor designed for very high power scientific, commercial, medical and industrial RF power generator and amplifier applications up to 40 MHz.

- **Specified 125 Volt, 27.12 MHz Characteristics:**
  - **Output Power = 750 Watts.**
  - **Gain = 17dB (Class C)**
  - **Efficiency > 75%**
- **RoHS Compliant**

- **High Performance Power RF Package.**
- **Very High Breakdown for Improved Ruggedness.**
- **Low Thermal Resistance.**
- **Nitride Passivated Die for Improved Reliability.**

MAXIMUM RATINGS

All Ratings: T_C = 25°C unless otherwise specified.

Symbol	Parameter	ARF1500	UNIT
V_{DSS}	Drain-Source Voltage	500	Volts
I_D	Continuous Drain Current @ T_C = 25°C	60	Amps
V_{GS}	Gate-Source Voltage	±30	Volts
P_D	Total Device Dissipation @ T_C = 25°C	1500	Watts
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to 175	°C
T_L	Lead Temperature: 0.063" from Case for 10 Sec.	300	

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
BV_{DSS}	Drain-Source Breakdown Voltage (V_{GS} = 0V, I_D = 250µA)	500			Volts
$V_{DS(ON)}$	On State Drain Voltage ① ($I_{D(ON)}$ = 30A, V_{GS} = 10V)		6	7.5	
I_{DSS}	Zero Gate Voltage Drain Current (V_{DS} = 500V, V_{GS} = 0V)			100	µA
	Zero Gate Voltage Drain Current (V_{DS} = 400V, V_{GS} = 0V, T_C = 125°C)			1000	
I_{GSS}	Gate-Source Leakage Current (V_{GS} = ±30V, V_{DS} = 0V)			±400	nA
g_{fs}	Forward Transconductance (V_{DS} = 25V, I_D = 30A)	6	7.5		mhos
$V_{isolation}$	RMS Voltage (60Hz Sinewave from terminals to mounting surface for 1 minute)	TBD			Volts
$V_{GS(TH)}$	Gate Threshold Voltage (V_{DS} = V_{GS}, I_D = 50mA)	3		5	Volts

THERMAL CHARACTERISTICS

Symbol	Characteristic (per package unless otherwise noted)	MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to Case			0.10	°C/W
$R_{\theta JHS}$	Junction to Sink (Use High Efficiency Thermal Joint Compound and Planar Heat Sink Surface.)		0.16		

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C_{iss}	Input Capacitance	$V_{GS} = 0V$ $V_{DS} = 150V$ f = 1 MHz		5150	6030	pF
C_{oss}	Output Capacitance			500	650	
C_{rss}	Reverse Transfer Capacitance			215	225	
$t_{d(on)}$	Turn-on Delay Time	$V_{GS} = 15V$ $V_{DD} = 250$ $I_D = 60A$ @ 25°C $R_G = 1.6\Omega$		7.5		ns
t_r	Rise Time			6.0		
$t_{d(off)}$	Turn-off Delay Time			20		
t_f	Fall Time			10		

FUNCTIONAL CHARACTERISTICS

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
G_{PS}	Common Source Amplifier Power Gain	f = 27.12 MHz $V_{GS} = 0V$ $V_{DD} = 125V$ $P_{out} = 750W$	17	19		dB
η	Drain Efficiency		70	75		%
Ψ	Electrical Ruggedness VSWR 10:1		No Degradation in Output Power			

① Pulse Test: Pulse width < 380 µS, Duty Cycle < 2%.

Microsemi reserves the right to change, without notice, the specifications and information contained herein.

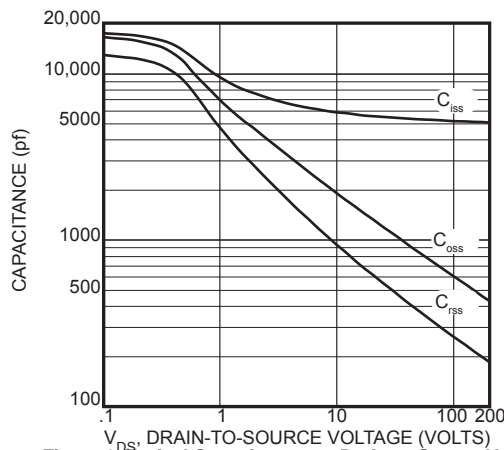Per transistor section unless otherwise specified.

Figure 1, Typical Capacitance vs. Drain-to-Source Voltage
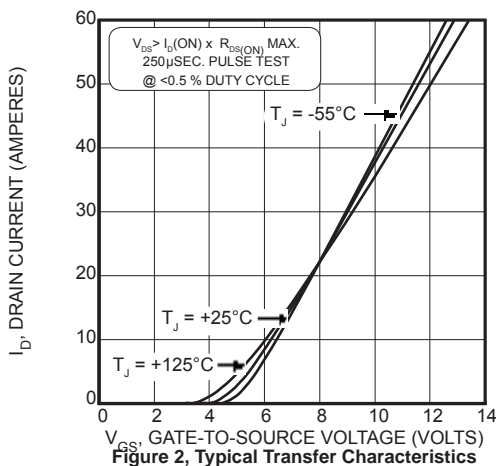

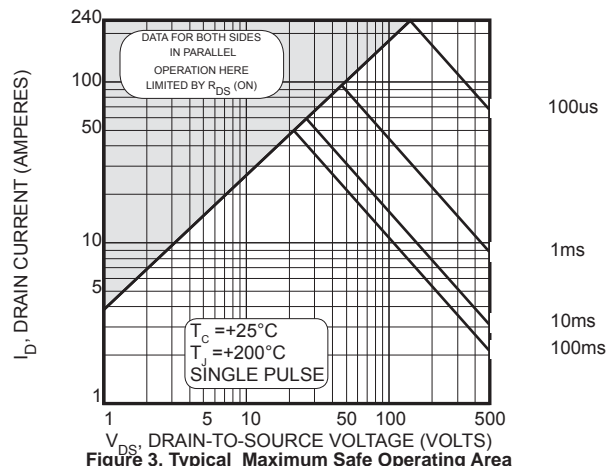
Figure 2, Typical Transfer Characteristics

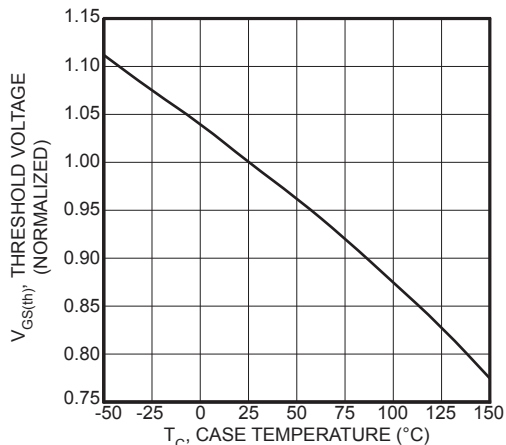Figure 3, Typical Maximum Safe Operating Area

Figure 4, Typical Threshold Voltage vs Temperature
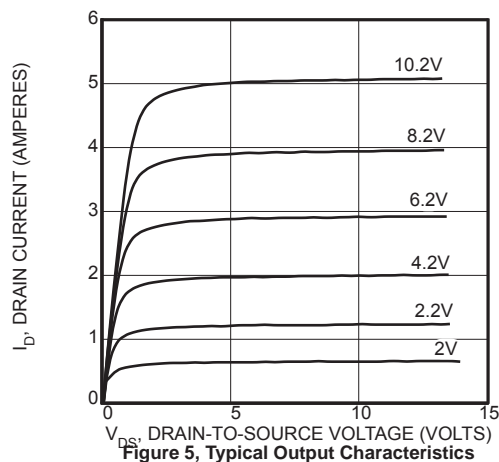

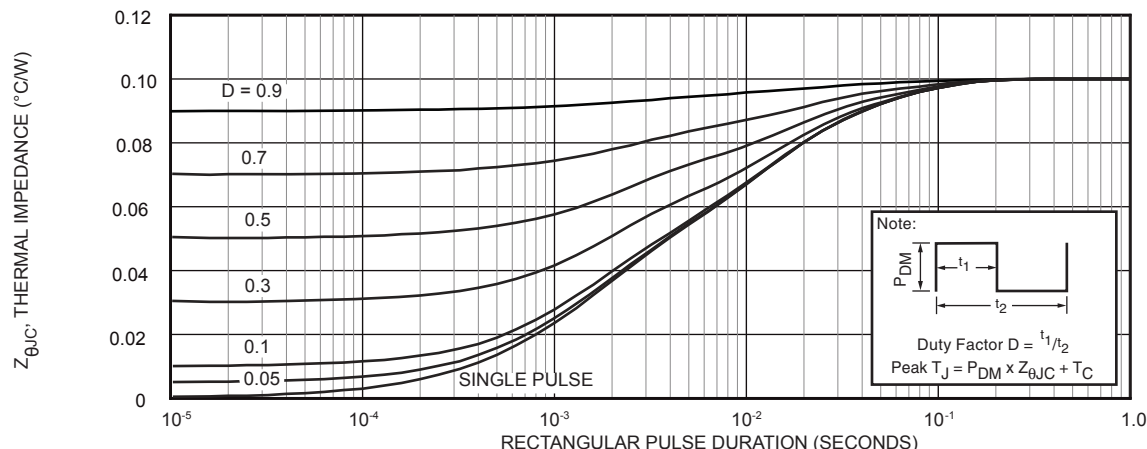Figure 5, Typical Output Characteristics

Figure 6, Maximum Effective Transient Thermal Impedance, Junction-to-Case vs. Pulse Duration

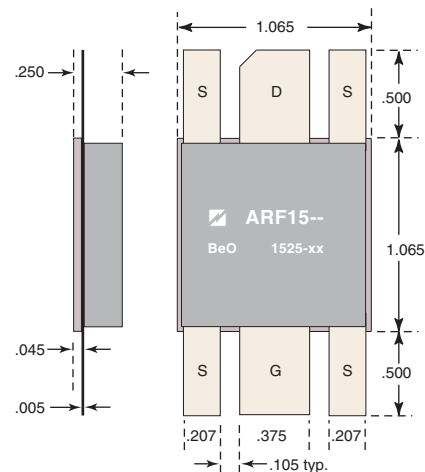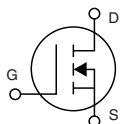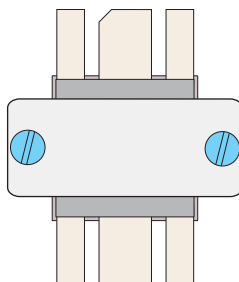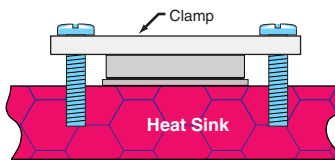Table 1 - Typical Class AB Large Signal Impedance -- ARF1500

F (MHz)	Z_{in} (Ω)	Z_{OL} (Ω)
2.0	6.7-j 12	7.5 -j 0.8
13.5	0.45 -j 2.5	7.1 -j 1.7
27	0.22 -j 0.67	6.1 -j 3.0
40	0.2 + j .19	5.0 -j 3.6

Z_{in} - Gate shunted with 25Ω I_{DQ} = 100mA
Z_{OL} - Conjugate of optimum load for 750 Watts
    output at V_{dd} = 125V

**Thermal Considerations and Package Mounting:**

The rated 1500W power dissipation is only available when the package mounting surface is at 25°C and the junction temperature is 175°C. The thermal resistance between junctions and case mounting surface is 0.10°C/W. When installed, an additional thermal impedance of 0.06°C/W between the package base and the mounting surface is smooth and flat. Thermal joint compound must be used to reduce the effects of small surface irregularities. The heatsink should incorporate a copper heat spreader to obtain best results.

The package is designed to be clamped to a heatsink. A clamped joint maintains the required mounting pressure while allowing for thermal expansion of both the device and the heat sink. A simple clamp, and two 6-32 (M3.5) screws can provide the minimum 125 lb. required mounting force. T=4-6 in-lb. Please refer to App Note 1802 "Mounting Instructions for Flangeless Packages."


Clamp
Heat Sink

ARF15--
BeO   1525-xx

1.065
.250
.500
1.065
.500
.045
.005
.207 .375 .207
.105 typ.
S D S
S G S

D
G
S

HAZARDOUS MATERIAL WARNING

The ceramic portion of the device between leads and mounting surface is beryllium oxide, BeO. Beryllium oxide dust is toxic when inhaled. Care must be taken during handling and mounting to avoid damage to this area . These devices must never be thrown away with general industrial or domestic waste.
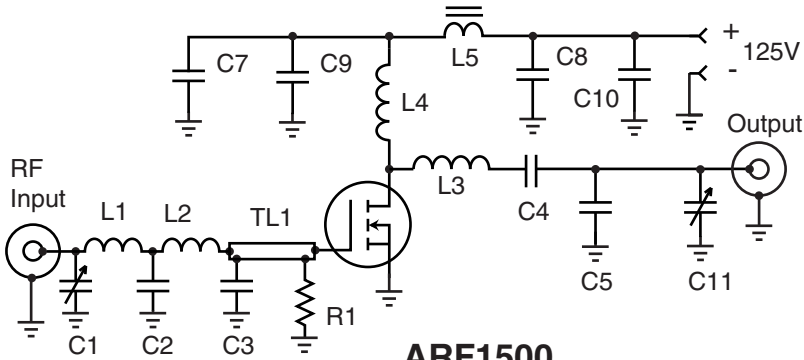
ARF1500
27.12 MHz Test Circuit

C1,C11 ARCO 465 50-450pF mica trimmer
C2 1500pF ATC 700B
C3 2x 3300 pF ATC 700B
C4 8200pF 500V NPO ceramic
C5 150pF 500V NPO
C7-C8 .1uF 250V ceramic chip
C9- C10 1000pF Z5U 500V
L1 120 nH 5t #20 .25"d .3"l
L2 20 nH #20 hairpin loop .3" x .125"
L3 175 nH - 4t #10 .625" dia .875" l
L4 2uH - 22t #24 enam. .312" dia.
L5 500nH 2t on 850u .5" bead
R1 51 Ω .5W
TL1 .25" x 1.75" (30 Ω) Stripline
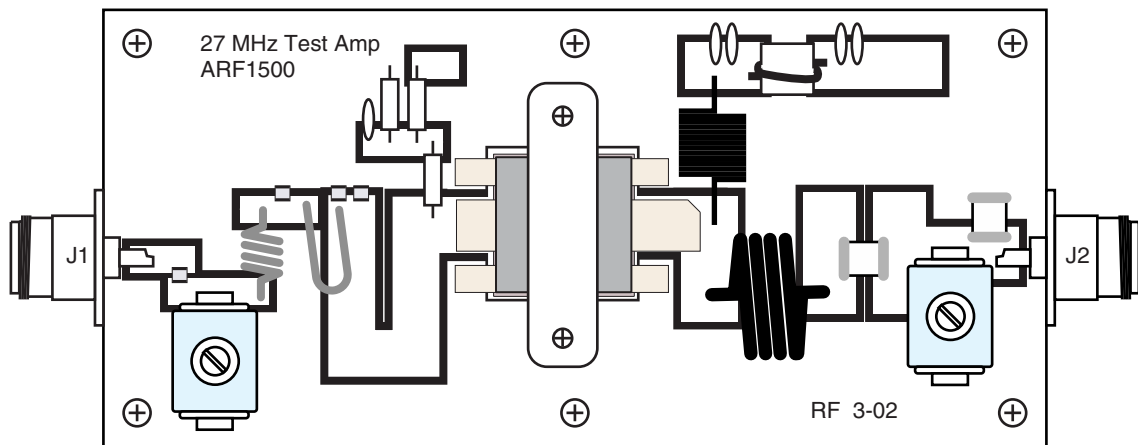
Parts placement
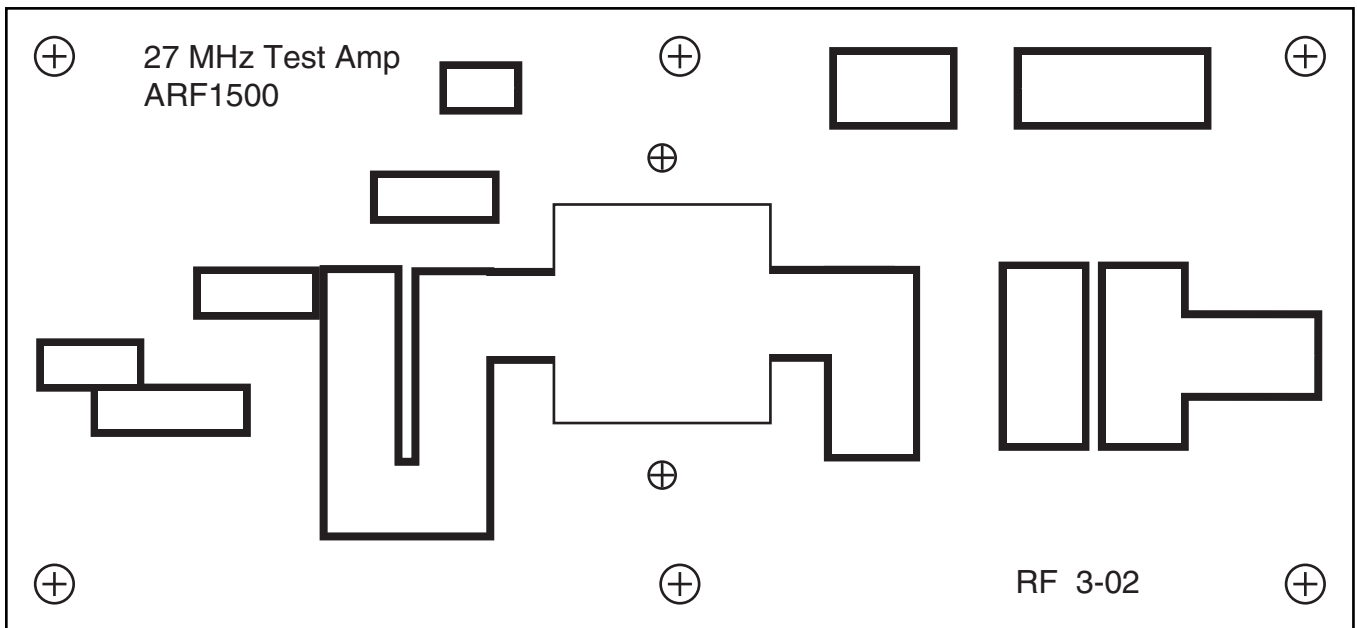
1:1 pcb artwork

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for RF MOSFET Transistors *category:*

Click to view products by Microchip *manufacturer:*

Other Similar products are found below :

FH2164 BLF245 ARF465BG VRF151MP MRF6S20010GNR1 DU28200M VRF2933MP VRF141 MMRF1015NR1 MW6S010GNR1 DU2820S MRF24301HR5 ARF463BP1G ARF465AG MMRF1014NT1 MRF422 VRF161MP ARF468BG MAPHST0045 A2T27S020NR1 UF2840P DU2860U VRF152GMP MRFE6VP5300NR1 BF2040E6814HTSA1 MRFE6VP5150NR1 MMRF5014HR5 LET9060S MRF175GV AFT27S010NT1 AFT27S006NT1 BF999E6327HTSA1 MRF1K50NR5 UF28150J MRFE6VP5600HR6 MRFX1K80HR5 BF998E6327HTSA1 AFM907NT1 AFT05MS006NT1 AFV10700HR5 MRF492 MRF141 MRF171 MRF172 MRF9045LR1 AFM906NT1 BLF578XR,112 TPM9305PD6 CJU02N65 FDS9926A